## **Bill of Materials**

## Bill of Materials For Project [BSE\_Project.PrjPCB] (No PCB Document Selected)

Source Data From: Project: Variant:		BSE_Project.PrjPCB			
		BSE_Project.P	rjPCB		
		None			
Creation Date:	9/2/2020	12:29:40 AM	_		
Print Date:	02-Sep-20	12:29:44 AM	_		
		I	_ 	I	<b>.</b>
Footprint	Comment	LibRef	Designator	Description	Quantity
Header3POS- SMD	Sensor Header	Header3POS- SMD	J1	Conn Shrouded Header (4 Sides) HDR 3 POS 1.5mm Solder RA SMD Pico-SPOX™ T/R	1
10k Rotary Encoder	10k pot	10k rotary encoder	R1	Res Cermet Trimmer 10K Ohm 30% 1(Elec)/1(Mech)Turn 4mm (11 X 14.9 X 3.1mm) Gull Wing SMD T/R	1
RES 0603	1.1k	RES 1.1k	R2	ERJPA3 Resistors 0.25W 0603 1K1 1%	1
RES 0603	2M	RES 2M	R3	Res Thick Film 0603 2MegaOhm 1% 1/4W ±100ppm/K Molded Paper T/R	1
Approved		Notes			